U.H.F. POWER TRANSISTOR

N-P-N silicon planar epitaxial transistor intended for transmitting applications in class-A, B or C with a supply voltage up to 28 V. The transistor is resistance stabilized and is guaranteed to withstand severe load mismatch conditions. Gold metallization ensures extremely high reliability.

It has a capstan envelope with a moulded cap. All leads are isolated from the stud.

QUICK REFERENCE DATA

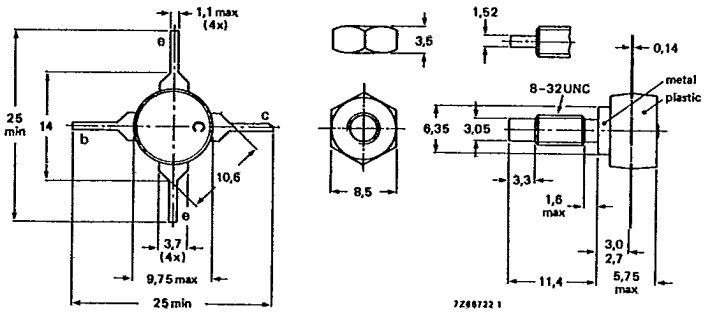
R.F. performance up to T_h = 25 °C in an unneutralized common-emitter class-B circuit

mode of operation	V_{CE} V	f MHz	P_S mW	P_L W	I_C mA	G_p dB	η %	$\overline{z_i}$ Ω	$\overline{Y_L}$ mS
c.w.	24	470	typ. 50	0,85	typ. 67	typ. 12,3	typ. 53	–	–
c.w.	28	470	< 80	1,0	< 71	> 11,0	> 50	–	–
c.w.	28	470	typ. 80	1,45	typ. 86	typ. 12,6	typ. 60	2,5 + j0,2	3,4 – j16
c.w.	28	1000	typ. 400	1,4	typ.100	typ. 5,4	typ. 50	–	–

MECHANICAL DATA

Dimensions in mm

Fig. 1 SOT-48/3.



Torque on nut: min. 0,75 Nm (7,5 kg cm)
max. 0,85 Nm (8,5 kg cm)

Diameter of clearance hole in heatsink: max. 4,2 mm.
Mounting hole to have no burrs at either end.
De-burring must leave surface flat; do not chamfer or countersink either end of hole.

When locking is required an adhesive is preferred instead of a lock washer.

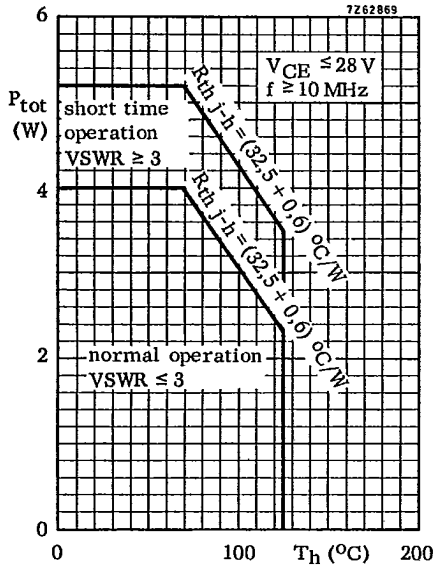
PRODUCT SAFETY This device incorporates beryllium oxide, the dust of which is toxic. The device is entirely safe provided that the BeO disc is not damaged.

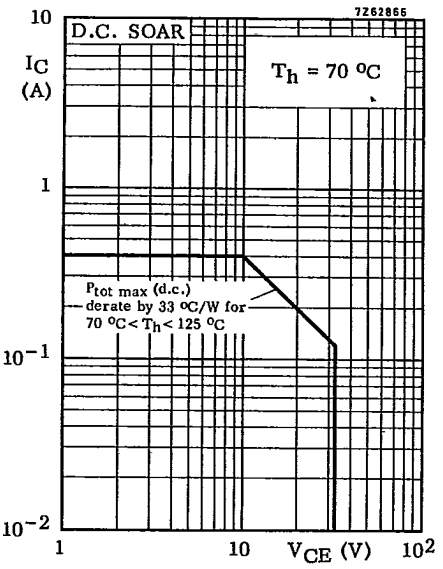
RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

Voltages				
Collector-base voltage (open emitter) peak value	V_{CBOM}	max.	65	V
Collector-emitter voltage (V_{BE} = 0) peak value	V_{CESM}	max.	65	V
Collector-emitter voltage (open base)	V_{CEO}	max.	33	V
Emitter-base voltage (open collector)	V_{EBO}	max.	4,0	V
Currents				
Collector current (d.c.)	I_C	max.	400	mA
Collector current (peak value); f ≥ 10 MHz	I_{CM}	max.	800	mA
Power dissipation				
Total power dissipation up to T_h = 70 °C f ≥ 10 MHz	P_{tot}	max.	4,0	W
Temperatures				
Storage temperature	T_{stg}	−65 to +150		°C
Operating junction temperature	T_j	max.	200	°C

THERMAL RESISTANCE

From junction to mounting base	$R_{th\ j\text{-}mb}$	=	32,5	K/W
From mounting base to heatsink	$R_{th\ mb\text{-}h}$	=	0,6	K/W



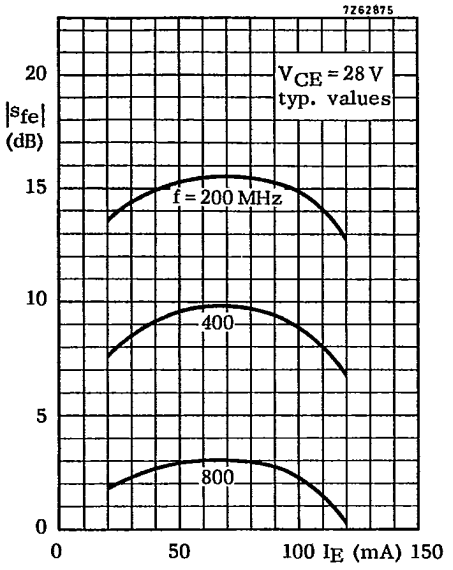


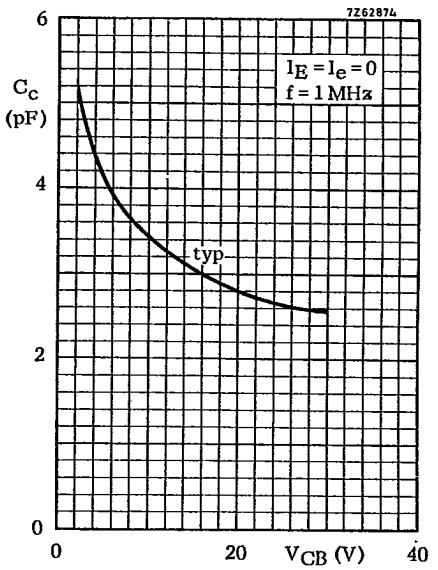
CHARACTERISTICS

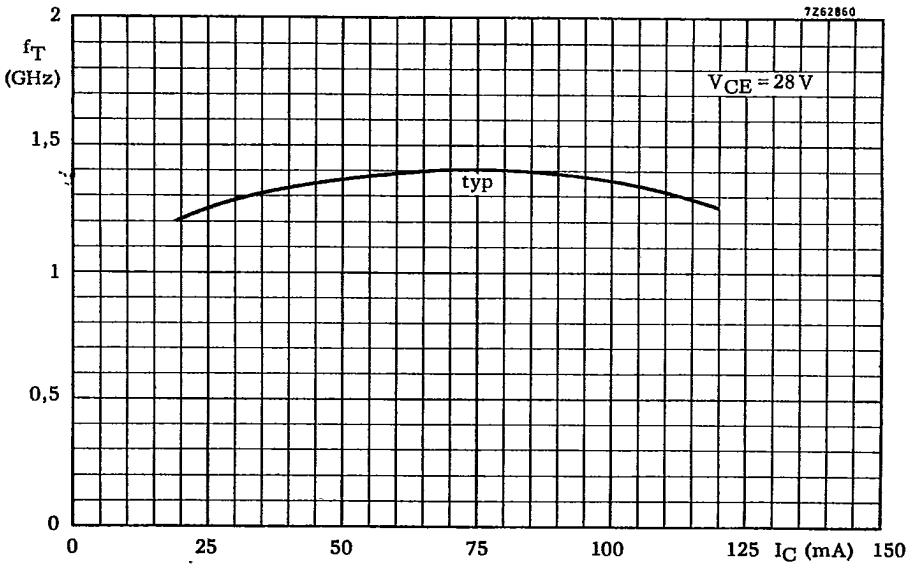
T_j = 25 °C unless otherwise specified

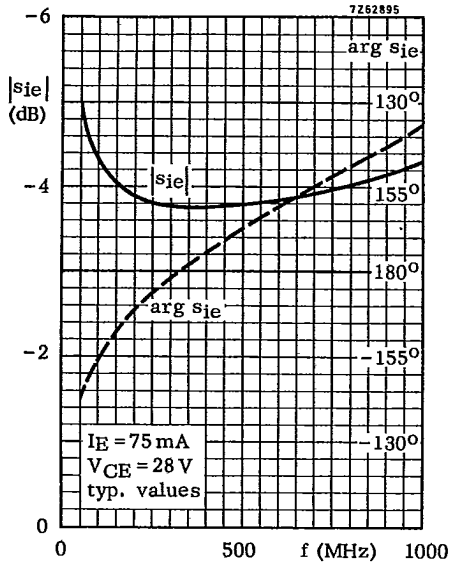
Breakdown voltages

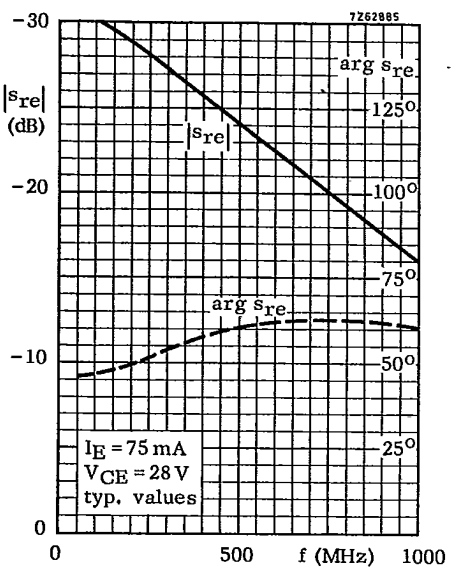
Collector-base voltage open emitter, I_C = 10 mA	$V_{(BR)CBO}$	>	65	V
Collector-emitter voltage V_{BE} = 0, I_C = 10 mA	$V_{(BR)CES}$	>	65	V
Collector-emitter voltage open base, I_C = 25 mA	$V_{(BR)CEO}$	>	33	V
Emitter-base voltage open collector, I_E = 1,0 mA	$V_{(BR)EBO}$	>	4,0	V
D.C. current gain I_C = 100 mA; V_{CE} = 5,0 V	h_{FE}	> typ.	10 35	
Transition frequency I_C = 50 mA; V_{CE} = 5,0 V	f_T	typ.	1,2	GHz
Collector capacitance at f = 1 MHz $I_E = I_e$ = 0; V_{CB} = 10 V	C_c	typ.	3,5	pF
Emitter capacitance at f = 1 MHz $I_C = I_c$ = 0; V_{EB} = 0	C_e	typ.	11	pF
Feedback capacitance at f = 1 MHz I_C = 5 mA; V_{CE} = 10 V	C_{re}	typ.	2,5	pF
Collector-stud capacitance	C_{cs}	typ.	2,0	pF

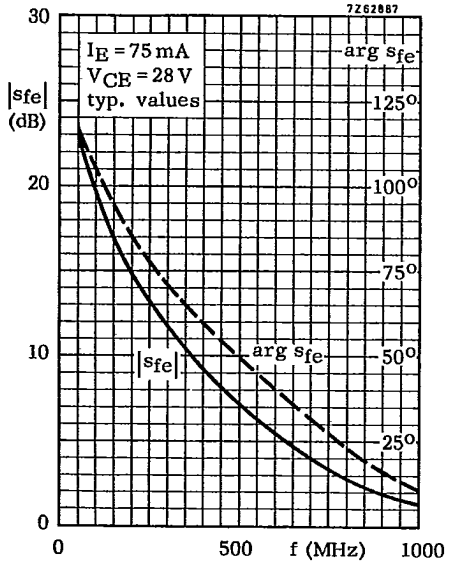


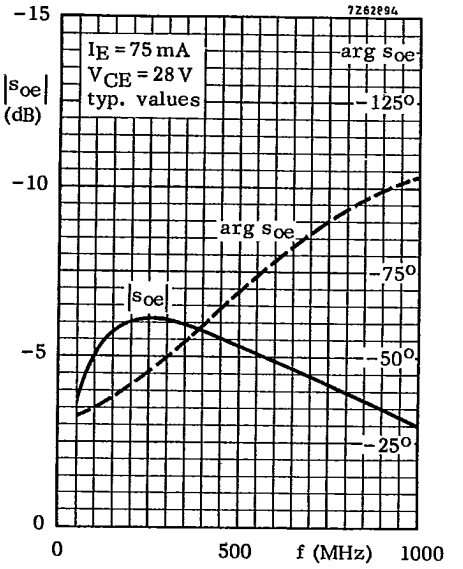












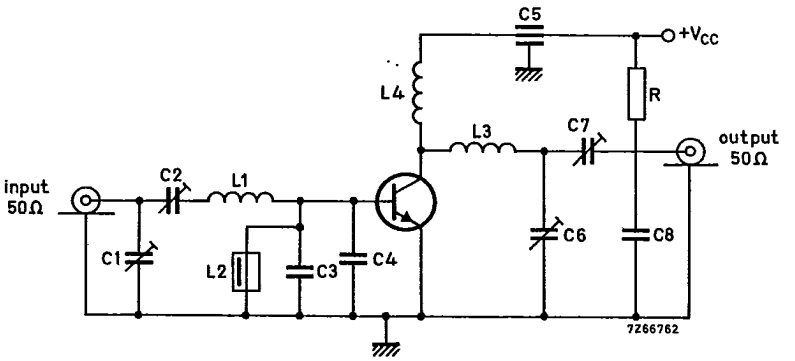
APPLICATION INFORMATION

R.F. performance in c.w. operation (Unneutralized common-emitter class-B circuit)

T_h = 25 °C

V_{CC} (V)	f (MHz)	P_S (mW)	P_L (W)	I_C (mA)	G_p (dB)	η (%)	$\overline{z_i}$ (Ω)	$\overline{Y_L}$ (mS)
24	470	typ. 50	0,85	typ. 67	typ. 12,3	typ. 53	–	–
28	470	< 80	1,0	< 71	> 11,0	> 50	–	–
28	470	typ. 80	1,45	typ. 86	typ. 12,6	typ. 60	2,5 + j0,2	3,4 – j16
28	1000	typ. 400	1,4	typ. 100	typ. 5,4	typ. 50	–	–

Test circuit for 470 MHz:



C1 = C2 = C7 = 1,8 to 18 pF film dielectric trimmer
C3 = C4 = 18 pF disc ceramic capacitor
C5 = 1 nF feed-through capacitor
C6 = 1,0 to 9,0 pF film dielectric trimmer
C8 = 0,1 µF polyester capacitor

L1 = 1 turn Cu wire (1,2 mm); int. dia. 5 mm; lead length = 2 mm
L2 = 0,47 µH choke
L3 = 4 turns closely wound enamelled Cu wire (1,2 mm); int. dia. 6,5 mm; lead length = 4 mm
L4 = 5 turns closely wound enamelled Cu wire (0,5 mm); int. dia. 4 mm; lead length = 5 mm

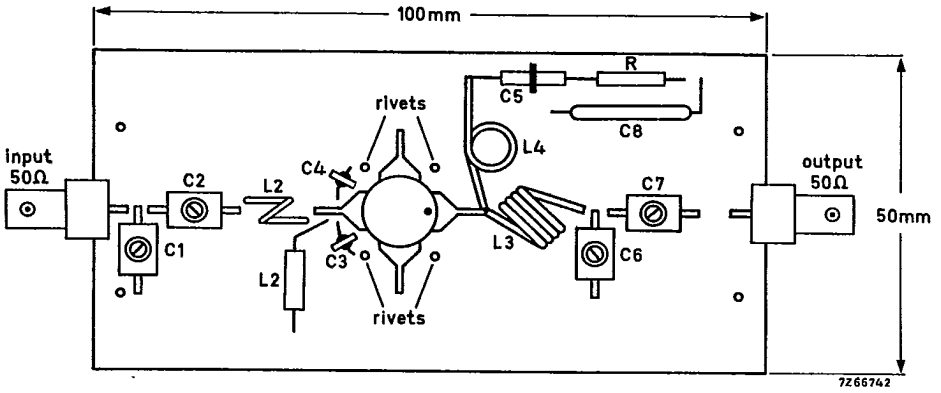
R = 10 Ω carbon

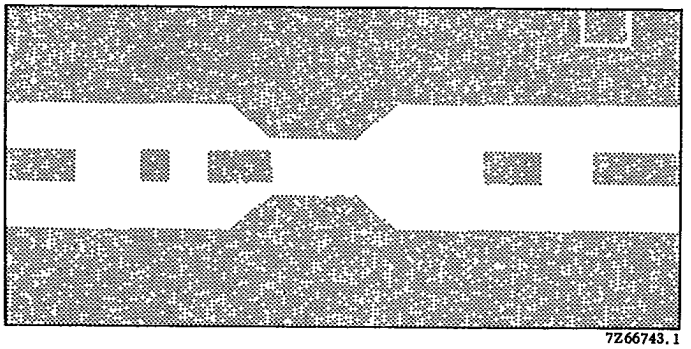
At P_L = 1,0 W and V_{CC} = 28 V, the output power at heatsink temperatures between 25 °C and 90 °C relative to that at 25 °C is diminished by typ. 2 mW/K

The transistor is designed to withstand full load mismatch in the test circuit under the following conditions: V_{CC} = 28 V; f = 470 MHz; T_h = 90 °C.
VSWR = 50 : 1 through all phases; P_L = 1,2 W.

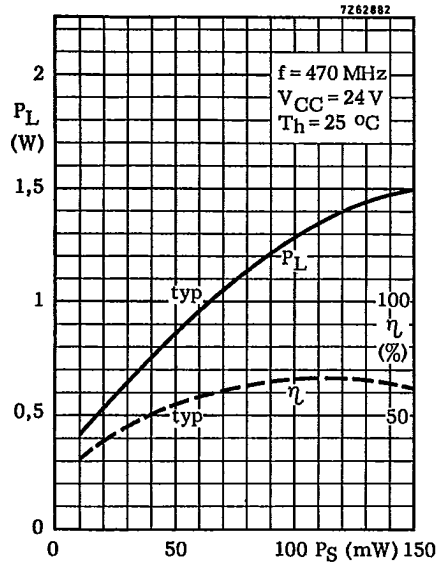
APPLICATION INFORMATION (continued)

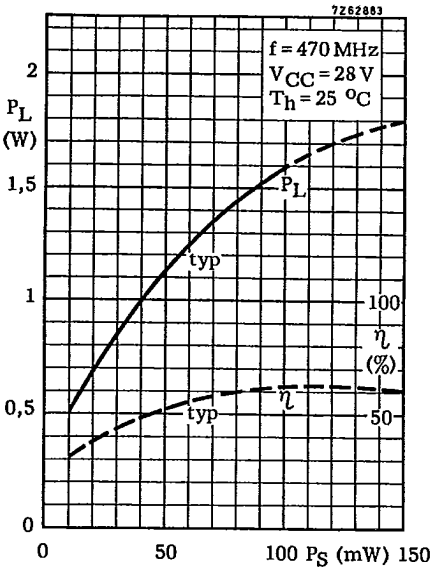
Component layout and printed-circuit board for 470 MHz test circuit.

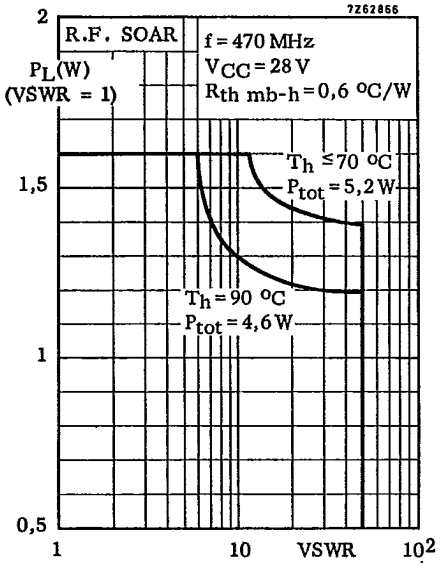




Shaded area copper
Back area completely copper clad
Material of printed-circuit board: 1,5 mm epoxy fibre-glass







Indicated load power as a function of overload

The graph has been derived from an evaluation of the performance of transistors matched up to 1,6 W load power in the test amplifier and subsequently subjected to various mismatch conditions at 28 V with VSWR up to 50 and elevated heatsink temperatures. This indicates a restriction to the load power matched under nominal conditions in the recommended test configuration.

OPERATING NOTE Below 350 MHz a base-emitter resistor of 10 Ω is recommended to avoid oscillation. This resistor must be effective for both d.c. and r.f.